

Applic. No. 10/653,653  
Amdt. dated July 19, 2006  
Reply to Office action of April 19, 2006

Claim Amendments

This listing of the claims will replace all prior versions,  
and listings, of claims in the application:

Claim 1 (currently amended): A sensor module comprising at least one sensor element that is at least partially surrounded by a housing, wherein the housing of the module is flexible, and a transmission means for wireless data transmission is integrated in the module, the flexible housing including at least two flexible foils, a first one of the flexible foils supporting the at least one sensor element and a second one of the flexible foils overlapping the first one of the flexible foils and supporting the transmission means.

Claim 2 (original): The sensor module of claim 1, wherein the transmission means contains an antenna and/or an induction coil.

Claim 3 (original): The sensor module of claim 1, wherein an operational voltage for the sensor module is inductively coupled in.

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Claim 4 (original): The sensor module of claim 1, wherein the operational voltage for the sensor module is electromagnetically coupled in.

Claim 5 (cancelled).

Claim 6 (original): The sensor module of claim 1, wherein the flexible housing is designed so that it may be vulcanized into a rubber tire.

Claim 7 (previously presented): The sensor module of claim 1, wherein the flexible housing is adapted to the geometry of a receiving unit.

Claim 8 (previously presented): The sensor module of claim 1, wherein the sensor module incorporates a memory element configured to store specific data that is not data sensed by the sensor element.

Claim 9 (original): The sensor module of claim 1, wherein the sensor element is a pressure sensor and the entire sensor module is inductively operated.

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Claim 10 (original): The sensor module of claim 9, wherein a gel is introduced between the flexible cover and the pressure sensor.

Claim 11 (previously presented): A method for producing a sensor module with at least one sensor element, the method comprising:

providing at least one sensor element being at least partially surrounded by a flexible housing; and

integrating transmission means for wireless data transmission into the module, the flexible housing including at least two flexible foils, a first one of the foils supporting the at least one sensor element and a second one of the foils overlapping the first one of the foils and supporting the transmission means.

Claims 12 and 13 (cancelled).

Claim 14 (new): A sensor module comprising at least one sensor element that is at least partially surrounded by a housing, wherein the housing of the module is flexible, and a transmission means for wireless data transmission is integrated in the module, the sensor module incorporating a

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memory element configured to store specific data that is not  
data sensed by the sensor element.